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Ralink and TrendChip Enter Into Merger Agreement

Combined Company is a Global Powerhouse for Wireless and Broadband Connectivity Semiconductors

Hsinchu, Taiwan, March 11, 2010 – Ralink Technology Corporation (TAIEX 3534, Ralink), a leading developer of high performance wireless solutions, and TrendChip Technologies Corporation (TAIEX 3614, TrendChip), a leading supplier of broadband connectivity chipsets, today announced that a merger agreement has been approved by the Board of Directors to create a global technology leader in the home networking and broadband access semiconductor markets. Under the terms of this agreement, the Board of Directors from both companies have agreed that the merged company will be called Ralink Technology Corporation, and that each 0.8209 share of TrendChip will be exchanged for 1 share of Ralink. With a combined stock valuation of approximately NT\$20 billion, and combined 2009 revenues

of over NT\$7.3 billion, the new Ralink Technology Corporation is among the world's "Top 30" fabless semiconductor companies as ranked by IC Insights based on revenue.

Ralink, founded in 2001, is headquartered in Hsinchu, Taiwan, and operates an advanced development center in Cupertino, California. Ralink's 802.11n solutions are shipping with customers in the Americas, Europe, and Asia, and are embedded in hundreds of products across all major Wi-Fi market segments including personal computers, broadband gateways, digital televisions, Blu-Ray players, web cameras, and IPTV set-top-boxes. TrendChip, also founded in 2001, is headquartered in Hsinchu, Taiwan, and maintains development centers in Suzhou and Nanjing China. TrendChip is among the fastest growing xDSL CPE semiconductor suppliers in the market with over 90% growth in 2009. TrendChip's solutions have been deployed by 50 carriers in 45 countries across Europe, Asia, and the Americas. With its high performance yet cost-effective xDSL solutions, TrendChip is on track to become the number 2 global xDSL CPE chip supplier in 2010.

"Ralink and TrendChip have worked closely over the past several years to win joint designs with common customers across the globe," said Shinjou Fang, Chairman of TrendChip Technologies. "Both Ralink and TrendChip share a similar vision of the Networked Digital Home, and both companies are executing on similar strategies to deliver industry-leading performance at disruptive price points. By merging the two companies Ralink Technology Corporation will be able to leverage our combined resources, operational efficiencies, and complementary technologies to deliver superior solutions to our customers and increased value to our shareholders."

"By combining Ralink and TrendChip into a single company, Ralink Technology Corporation will be positioned to drive the growth of high-performance yet cost-effective 'triple play' voice, video, and data services throughout the Networked Digital Home," said Chris Kao, Chairman of Ralink Technology. "Broadband Gateways will incorporate our DSL and Wi-Fi chipsets, and they will deliver wireless content throughout the home to personal computers, televisions, phones, and other consumer electronics devices. With our combined forces and technologies, we anticipate accelerated growth in both existing and adjacent market segments over the coming years."

Management of the combined 600 person company will include executives and board members from both organizations. To streamline integration of the two companies, and to maximize operational efficiencies during the transition period, Ralink Technology's Board of Directors has appointed Shinjou Fang, Chairman of TrendChip Technologies, to be CEO of Ralink Technology and Chris Kao will continue to serve as Chairman.

About Ralink Technology

Ralink Technology Corporation is a leading innovator and developer of wireless chipset

solutions. Our products are recognized for their superior throughput, extended range, low-power consumption, and consistent reliability. Ralink's patented Wi-Fi technology is used in various applications including traditional PC networking, broadband gateway connectivity, and consumer electronics applications. Ralink Technology was founded in 2001 with headquarters in Hsinchu, Taiwan and maintains an Advanced R&D center in Cupertino, California. For more information about Ralink please visit our website at <http://www.ralinktech.com>

About TrendChip Technologies

TrendChip Technologies Corporation is a leading supplier of broadband access chipsets. The company's cost-effective ADSL chipsets and software deliver industry-leading performance that has been widely adopted by world-class telecommunications customers across the globe. Worldwide product shipments have grown steadily since the company was founded in 2001, and grew by more than 90 percent in 2009 enabling the company to achieve more than 25% global market share in 2009. For more information about Trendchip, please visit our website at <http://www.trendchip.com.tw>

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